L Number	Hits	Search Text	DB	Time stamp
2	939938	chip or die	USPAT;	2003/09/17 13:36
	757750		US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
,	1161535	wire	USPAT;	2003/09/17 13:36
3	1101555		US-PGPUB;	
			EPO; JPO;	
•			DERWENT;	
!	ŧ		IBM_TDB	
	2605604	encapsula\$5 or mold\$4 or pot\$4 or resin	USPAT;	2003/09/17 13:37
4	2003004	cheapsulass of molast of post of the	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
ļ			IBM TDB	
] _	445026	atab \$4	USPAT;	2003/09/17 13:37
5	445826	etch\$4	US-PGPUB;	
			EPO; JPO;	
	ļ		DERWENT;	
			IBM_TDB	
	1011067	an anaming on trough or furrow or channel	USPAT;	2003/09/17 13:39
8	4041867	groove or opening or trench or furrow or channel	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
		and the second of the second o	USPAT;	2003/09/17 13:40
11	868	(chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and	US-PGPUB;	
		(etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.	EPO; JPO;	
			DERWENT;	
	-		IBM TDB	
			USPAT;	2003/09/17 13:42
10	2104	438/110,112,113,121,124.ccls.	US-PGPUB;	2000,0270
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
		(1) 1 (an angula 65 or mold 64 or not 64 or regin) and	_	2003/09/17 15:47
12	485	((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and	US-PGPUB;	
		(etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) and	EPO; JPO;	
		(groove or opening or trench or furrow or channel)	DERWENT;	
			IBM TDB	
		(NECCESTON MEGECO1011 MCC22005011 MCC20402011) DNI	USPAT	2003/09/17 14:23
13	4	("5656550" "5976912" "6238952" "6294830").PN.	USPAT	2003/09/17 14:54
14	7	("4558812" "5151276" "5293072" "5355283" "5358904"	USIAI	2005/05/17 1910
		"5475236" "5508556").PN.	USPAT	2003/09/17 14:55
15	27		USPAT	2003/09/17 15:43
16	2	2 ("5592025" "5635755").PN.	USPAT	2003/09/17 15:43
17	17	6025640.URPN.		2003/09/17 16:10
18	383	((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and	US-PGPUB;	2000,00,17 10.10
		(etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) not	EPO; JPO;	
		(((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin)	DERWENT;	
		and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.)	IBM_TDB	
		and (groove or opening or trench or furrow or channel))	_	2003/09/17 16:11
19	310) 438/111.ccls.	USPAT;	
			US-PGPUB; EPO; JPO;	
			, , , ,	
			DERWENT;	
			IBM_TDB	_1

20	228	438/111.ccls. not (((chip or die) and wire and (encapsula\$5 or mold\$4 or	USPAT; US-PGPUB;	2003/09/17 16:11
		pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) and (groove or opening or trench or furrow or channel)) (("5656550" "5976912" "6238952" "6294830").PN.) (("4558812" "5151276" "5293072" "5355283" "5358904" "5475236" "5508556").PN.) 5656550.URPN. (("5592025" "5635755").PN.) 6025640.URPN. (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) not (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) and (groove or opening or trench or furrow or channel))))	EPO; JPO; DERWENT; IBM_TDB	
21	96	(438/111.ccls. not (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) and (groove or opening or trench or furrow or channel)) (("5656550" "5976912" "6238952" "6294830").PN.) (("4558812" "5151276" "5293072" "5355283" "5358904" "5475236" "5508556").PN.) 5656550.URPN. (("5592025" "5635755").PN.) 6025640.URPN. (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) not (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) and (groove or opening or trench or furrow or channel))))) and (chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/17 16:32
22	443	29/884.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/17 16:34
23	8474	29/827,854,855,856.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/17 16:34
24	8337	29/827,854,855,856.ccls. not (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) (("5656550" "5976912" "6238952" "6294830").PN.) (("4558812" "5151276" "5293072" "5355283" "5358904" "5475236" "5508556").PN.) 5656550.URPN. (("5592025" "5635755").PN.) 6025640.URPN. (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) not (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) and (groove or opening or trench or furrow or channel))) ((438/111.ccls. not (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) and (groove or opening or trench or furrow or channel)) (("5656550" "5976912" "6238952" "6294830").PN.) (("4558812" "55151276" "5293072" "5355283" "5358904" "5475236" "5508556").PN.) 5656550.URPN. (("5592025" "5635755").PN.) 6025640.URPN. (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) not (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) not (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) not (((chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and 438/110,112,113,121,124.ccls.) and (groove or opening or trench or furrow or channel))))) and (chip or die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin)) 29/884.ccls.)	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/17 16:35

		Leader and and and the second of the second	USPAT;	2003/09/17 16:36
25	886	(29/827,854,855,856.ccls. not (((chip or die) and wire and (encapsula\$5	US-PGPUB;	2003/07/17 10.30
1		or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or separat\$4) and	EPO; JPO;	
		438/110,112,113,121,124.ccls.) (("5656550" "5976912" "6238952"		
		"6294830").PN.) (("4558812" "5151276" "5293072" "5355283"	DERWENT;	
		"5358904" "5475236" "5508556").PN.) 5656550.URPN. (("5592025"	IBM_TDB	
		"5635755").PN.) 6025640.URPN. (((chip or die) and wire and		
		(encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or		
		separat\$4) and 438/110,112,113,121,124.ccls.) not (((chip or die) and		
		wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4		
		or separat\$4) and 438/110,112,113,121,124.ccls.) and (groove or opening		
		or trench or furrow or channel))) ((438/111.ccls. not (((chip or die) and		
		wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4		
		or separat\$4) and 438/110,112,113,121,124.ccls.) (((chip or die) and wire		į
		and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or		
		separat\$4) and 438/110,112,113,121,124.ccls.) and (groove or opening or		
		trench or furrow or channel)) (("5656550" "5976912" "6238952"		
		"6294830").PN.) (("4558812" "5151276" "5293072" "5355283"		
		"5358904" "5475236" "5508556").PN.) 5656550.URPN. (("5592025"		
}		"5635755").PN.) 6025640.URPN. (((chip or die) and wire and		
		(encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4 or		
		separat\$4) and 438/110,112,113,121,124.ccls.) not (((chip or die) and		
		wire and (encapsula\$5 or mold\$4 or pot\$4 or resin) and (etch\$4 or dic\$4		
		or separat\$4) and 438/110,112,113,121,124.ccls.) and (groove or opening		
		or separato4) and 456/110,112,115,121,124.ccis.) and (groove or opening		
		or trench or furrow or channel))))) and (chip or die) and wire and		
		(encapsula\$5 or mold\$4 or pot\$4 or resin)) 29/884.ccls.)) and (chip or		
		die) and wire and (encapsula\$5 or mold\$4 or pot\$4 or resin)		<u></u>